



PRODUCT DATASHEET



- PLCC2 SMD
- 2835 0.8t Series
- ► Warm White (2900K)





N0W17S06

APPLICATIONS:

- General Lighting
- Portable Lighting
- Commercial Lighting
- Indoor Lighting

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Backlight for LCD

2835 0.8t Series



FEATURES:

- Package: PLCC2 0.2W White SMD Package
- Forward Current: 60mA
- Forward Voltage (typ.): 3.1V
- Luminous Flux (typ.): 16lm@60mA
- Colour: Warm White
- Colour Temperature (CCT): 2900K
- Viewing angle: 120°
 - Materials:
 - Die: InGaN
 - Resin: Silicon (Yellow Diffused)
 - L/T Finish: Ag plated
- Operating Temperature: -40~+80°C
- Storage Temperature: -40~+100°C
- Grouping parameters:
 - Forward Voltage
 - Luminous Flux
 - CIE Chromaticity
- Soldering methods: Reflow Soldering
- **Preconditioning:** MSL3 according to JEDEC
- Packing: 8mm tape with 4000/reel, ø180mm (7")



CHARACTERISTICS:

Absolute Maximum Characteristics (Ta=25°C)

Parameter	Symbol	Ratings	Unit
DC Forward Current	I _F	100	mA
Pulse Forward Current (Duty 1/10; width 0.1ms)	I _{PF}	200	mA
Reverse Current @5V	I _R	10	μΑ
Junction Temperature	Tj	110	°C
Electrostatic Discharge (HBM)	ESD	1000	V
Operating Temperature	T _{OPR}	-40~+80	°C
Storage Temperature	T _{STG}	-40~+100	°C
Soldering Temperature	T _{SOL}	260	°C
Colour Rendering Index	CRI	90 (typ.)	

Electrical & Optical Characteristics (Ta=25°C)

Parameter	Symbol	Values			Unit	Test	
Parameter	Symbol	Min.	Тур.	Max.	Onit	Condition	
Forward Voltage	$V_{\rm F}$	2.8	3.1	3.6	V	I _F =60mA	
Luminous Flux	Φν	14	19	20	lm	I _F =60mA	
Chromaticity	х		0.4398				
Coordinates	Y		0.4048			I _F =60mA	
Colour Temperature	ССТ	2725	2870	3045	к	I _F =60mA	
Viewing Angle	20 _{1/2}		120		deg	I _F =60mA	

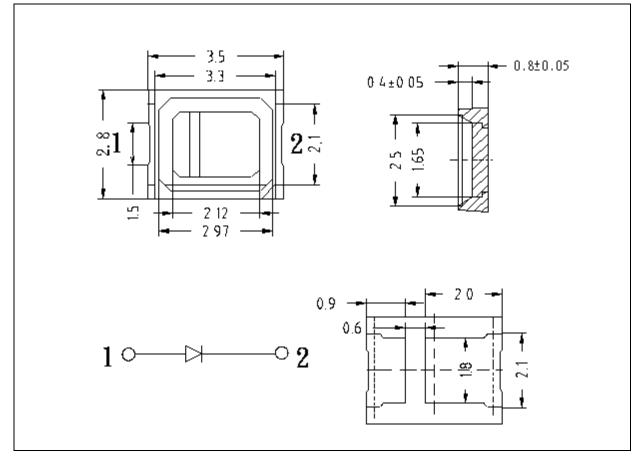
1. Luminous flux (Φ_v) ±10%, Forward Voltage (V_F) ±0.1V, Viewing angle(2 $\theta_{1/2}$) ±5

2. IS standard testing



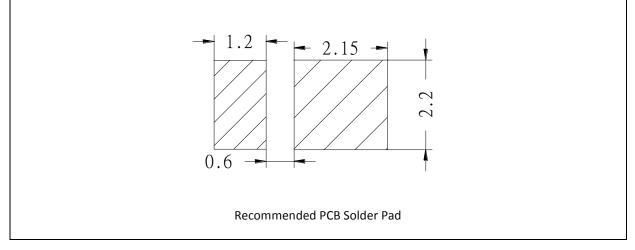


Package Dimension:



- 1. All dimensions are in millimetre (mm).
- 2. Tolerance ±0.13mm, unless otherwise noted.

Recommended Soldering Pad Dimension:



- 1. Dimensions are in millimetre (mm).
- 2. Tolerance ± 0.1 mm with angle tolerance $\pm 0.5^{\circ}$.



BINNING GROUPS:

0	()		
Code	Min.	Max.	Unit
В	2.8	2.9	
С	2.9	3.0	
D	3.0	3.1	
E	3.1	3.2	V
F	3.2	3.3	v
G	3.3	3.4	
н	3.4	3.5	
I	3.5	3.6	

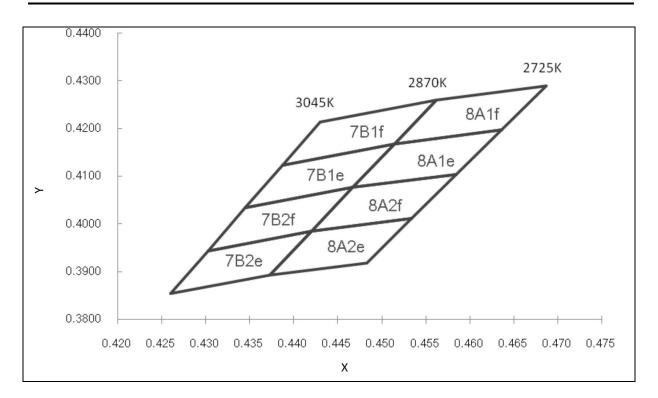
Forward Voltage Classifications ($I_F = 60mA$):

Luminous Flux Classifications (I_F = 60mA):

Code	Min.	Max.	Unit
13	14	16	
14	16	18	Im
15	18	20	



CIE CHROMATICITY DIAGRAM:

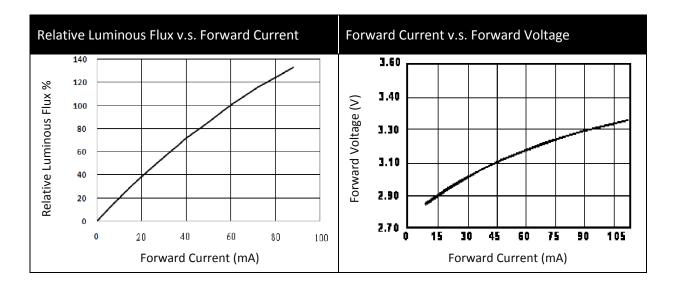


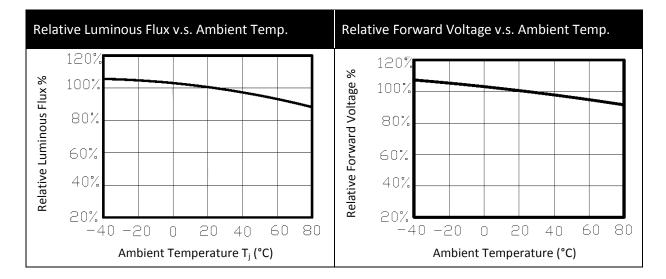
Chromaticity Coordinates Classifications ($I_F = 60 \text{mA}$):

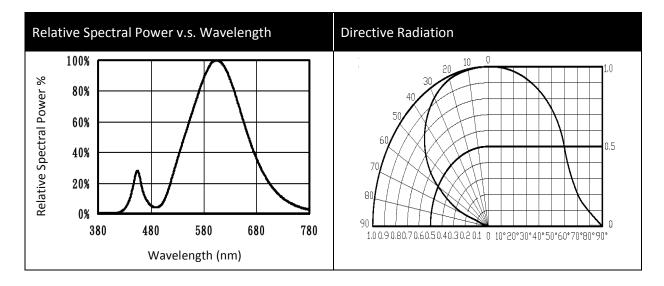
	1		2		3		4	
	Х	Y	Х	Y	х	Y	Х	Y
7B1f	0.4562	0.4260	0.4515	0.4168	0.4388	0.4123	0.4430	0.4213
7B1e	0.4515	0.4168	0.4467	0.4076	0.4345	0.4033	0.4388	0.4123
7B2f	0.4467	0.4076	0.4420	0.3985	0.4303	0.3944	0.4345	0.4033
7B2e	0.4420	0.3985	0.4373	0.3893	0.4260	0.3854	0.4303	0.3944
8A1f	0.4687	0.4289	0.4636	0.4197	0.4515	0.4168	0.4562	0.4260
8A2f	0.4585	0.4104	0.4534	0.4011	0.4420	0.3985	0.4467	0.4076
8A1e	0.4636	0.4197	0.4585	0.4104	0.4467	0.4076	0.4515	0.4168
8A2e	0.4534	0.4011	0.4483	0.3918	0.4373	0.3893	0.4420	0.3985



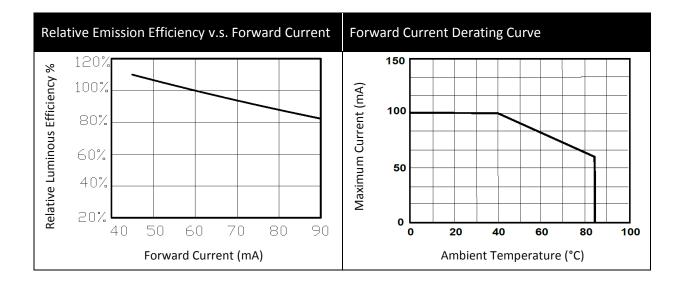
ELECTRO-OPTICAL CHARACTERISTICS:





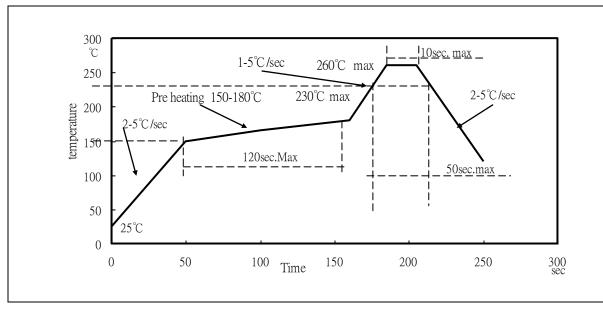








RECOMMENDED SOLDERING PROFILE:



Lead-free Solder:

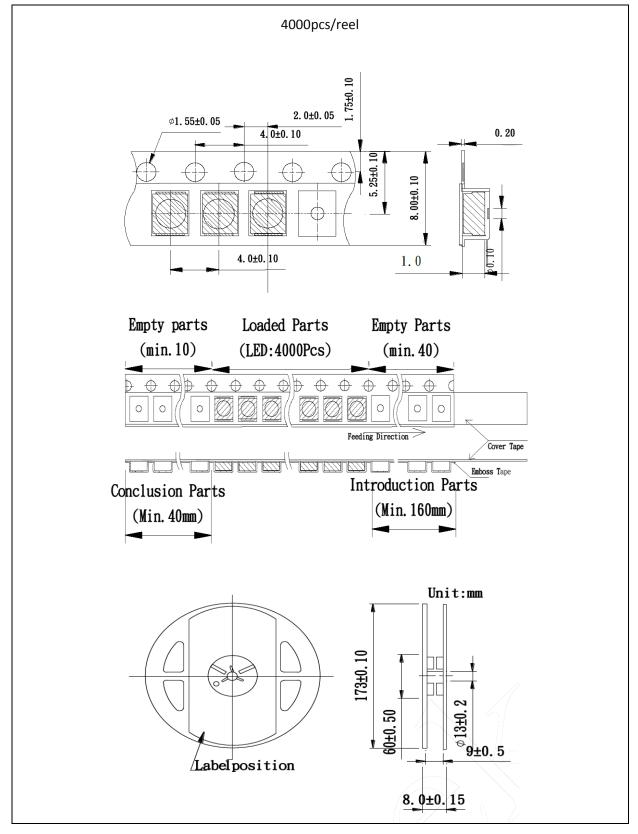
Note:

- 1. Maximum reflow soldering: 3 times.
- 2. Recommended reflow temperature: 240°C. Maximum soldering temperature should be limited to 260°C.
- 3. Before, during, and after soldering, should not apply stress on the components and PCB board.



PACKING SPECIFICATION:

Reel Dimension:



PRECAUTIONS OF USE:



Storage:

It is recommended to store the products in the following conditions:

- Humidity: 60% R.H. Max.
- Temperature: 5°C~30°C (41°F ~86°F).

Shelf life in sealed bag: 12 month at 5°C~30°C and <60% R.H.

Once the package is opened, the products should be used within a week. Otherwise, they should be kept in a damp-proof box with descanting agent and apply baking at 60°C±5°C for 15hrs before use.

Baking:

It is recommended to bake the LED before soldering if the pack has been unsealed for longer than 24hrs. The suggested baking conditions are as followings:

- 70±3°C x 24hrs and <5%RH, taped / reel package.
- 100±3°C x 2hrs, bulk (loose) package.
- 130±3°C x 30min, bulk (loose) package.

It's normal to see slight color fading of carrier (light yellow) after baking in process.

Testing Circuit:



Must apply resistor(s) for protection (over current proof).

Cleaning:

Use alcohol-based cleaning solvents such as isopropyl alcohol to clean the LED carrier / package. Avoid putting any stress force directly on to the LED lens.

ESD (Electrostatic Discharge):

Static Electricity or power surge will damage the LED. Use of a conductive wrist band or anti-electrosatic glove is recommended when handing the LED all time. All devices, equipment, machinery, work tables, and storage racks must be properly grounded.

In the events of manual working in process, make sure the devices are well protected from ESD at any time.



REVISION RECORD:

Version	Date	Summary of Revision
A1.0	31/03/2015	Datasheet set-up.